

Evaluation platform 1200 V CoolSiC™ MOSFET in TO247 3-pin / 4-pin Rev. 2.0

Switching loss extraction for surface mount and through hole devices

About this document

Scope and purpose

This user guide describes the double-pulse evaluation platform, which is used to extract switching losses for discretes in TO247 3-pin and 4-pin packages, and the daughter cards that fit on the board.

Intended audience

This document is intended for owners and users of the evaluation board. Only trained persons should operate the board!

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Safety precautions

Safety precautions

Note: Please note the following warnings regarding the hazards associated with development systems.

Table 1 Safety precautions

	Warning: The DC link potential of this board is up to 800 VDC. When measuring voltage waveforms by oscilloscope, high voltage differential probes must be used. Failure to do so may result in personal injury or death.
	Warning: The evaluation board contains DC bus capacitors which take time to discharge after removal of the main supply. Failure to do so may result in personal injury or death. Darkened display LEDs are not an indication that capacitors have discharged to safe voltage levels.
	Caution: The heat sink and device surfaces of the evaluation board may become hot during testing. Hence, necessary precautions are required while handling the board. Failure to comply may cause injury.
	Caution: Only personnel familiar with power electronics and associated machinery should plan, install, commission and subsequently service the system. Failure to comply may result in personal injury and/or equipment damage.
	Caution: The evaluation board contains parts and assemblies sensitive to electrostatic discharge (ESD). Electrostatic control precautions are required when installing, testing, servicing or repairing the assembly. Component damage may result if ESD control procedures are not followed. If you are not familiar with electrostatic control procedures, refer to the applicable ESD protection handbooks and guidelines.
	Caution: The evaluation or reference board is shipped with packing materials that need to be removed prior to installation. Failure to remove all packing materials that are unnecessary for system installation may result in overheating or abnormal operating conditions.

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1 The board at a glance

The evaluation platform was developed to give users the opportunity to investigate the switching behavior of MOSFETs, IGBTs and their drivers using through-hole and surface mounting. It is an improved version of the existing double-pulse platform [1]. The following improvements were made:

- Through-hole sockets instead of solder points for the device under test (DUT): this allows for an easy replacement of the DUT for repetitive measurements. To reduce the lead inductance, Infineon recommends reducing the leads to a minimum.
- Surface-mount shunt resistor in parallel to coaxial shunt give users the freedom to choose one or the other for their current measurement
- Improved regulation of the negative supply voltage for the driver
- Additional connector X101 as interface from the driver to a microcontroller
- Fixed voltage probe holders for the low-side switch VGS and VDS
- Test points added

Temperature is an additional factor influencing the switching behavior. To investigate this effect, it is possible to mount a heat sink with heating element on the board.

1.1 Delivery content

The scope of supply includes the EVAL-SiC-DP-V2 motherboard packed in a box

Table1

Product description name	CoolSiC™ MOSFET 1200 V evaluation platform V2
Sales product name	EVAL-PS-DB-MAIN
OPN	EVALPSDPMaintOBO1
SP number	SP005572487
Content	• Motherboard (CoolSiC™ MOSFET 1200 V evaluation board) – 1 pc

1.2 Block diagram

Figure 1 shows the block diagram of the motherboard where the core is the half-bridge consisting of S1 and S2. S1 could also be replaced by a diode. The inductor L1 is excluded from the board and is not part of the delivery.

The board at a glance

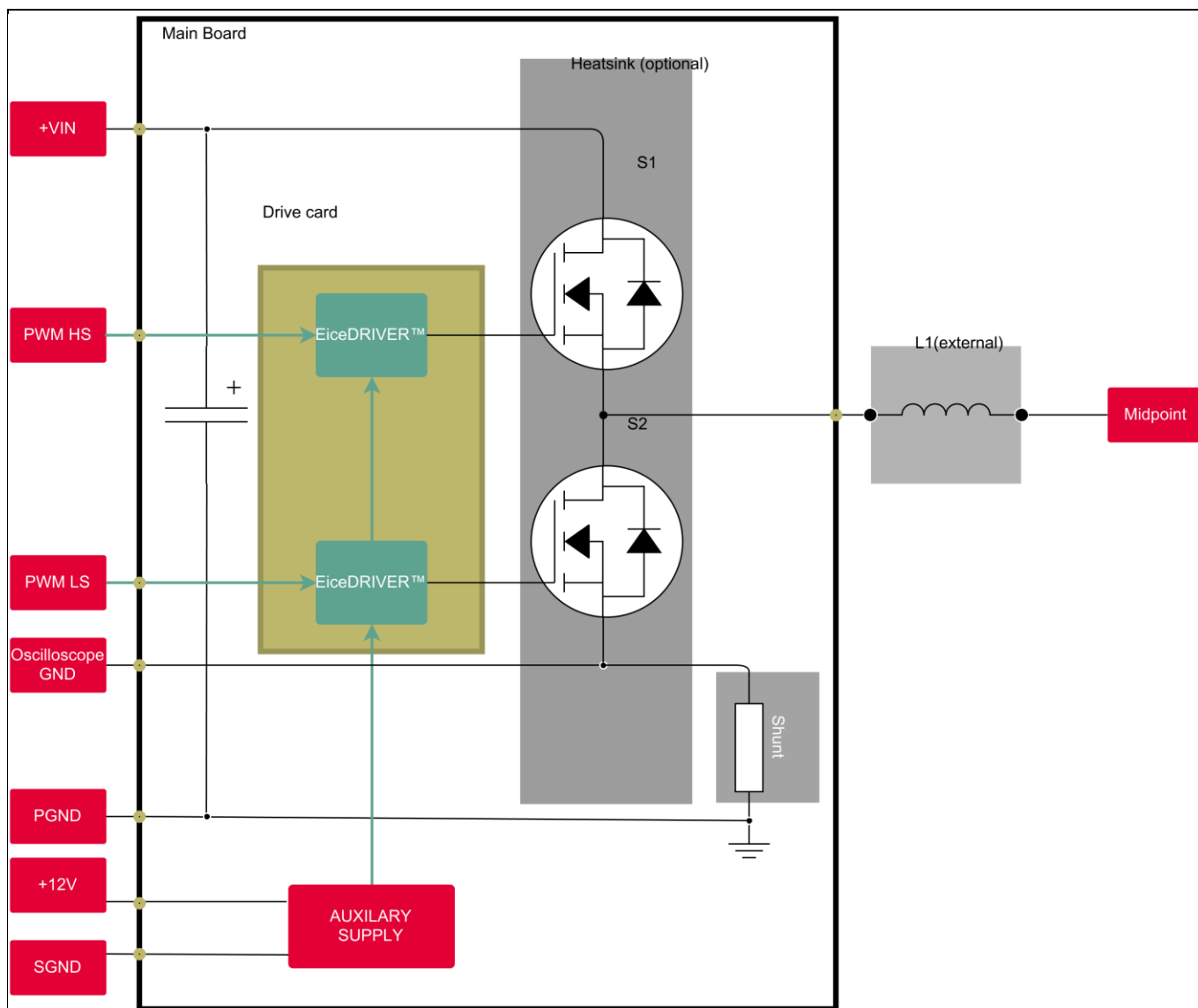


Figure 1 **Evaluation platform block diagram**

1.3 Main features

- Switching loss calculation
- Easy replacement of the DUT as well as the daughterboards on their connectors
- Fixed probe holders for low-side, gate-source and drain-source voltage measurements
- DC bus up to 800 V tested

1.4 Board parameters and technical data

Main technical data related to the motherboard

Table 2 **Parameter**

Parameter	Symbol	Conditions	Value	Unit
High voltage input	+VIN		800	V
Auxiliary supply voltage	+12 V		12	V

The board at a glance

Parameter	Symbol	Conditions	Value	Unit
Maximum pulsed current	I_{max}		130	A
Mechanical dimensions	length		180	mm
	width		100	mm

2 System and functional description

The following chapter gives a functional explanation of the board shown in Figure 2 and Figure 3. The board is split into a primary and secondary section indicated on the board silkscreen. The primary section contains the auxiliary and logic part, and the secondary section the “power” part. Figure 3 shows the jumper settings for the drive voltages and the signal names for a 3-pin and 4-pin configuration. Beside the fixed voltage probe holders, SMD test points are available, from where the corresponding signals can be accessed. For the high-side voltage measurements, differential probes are mandatory.

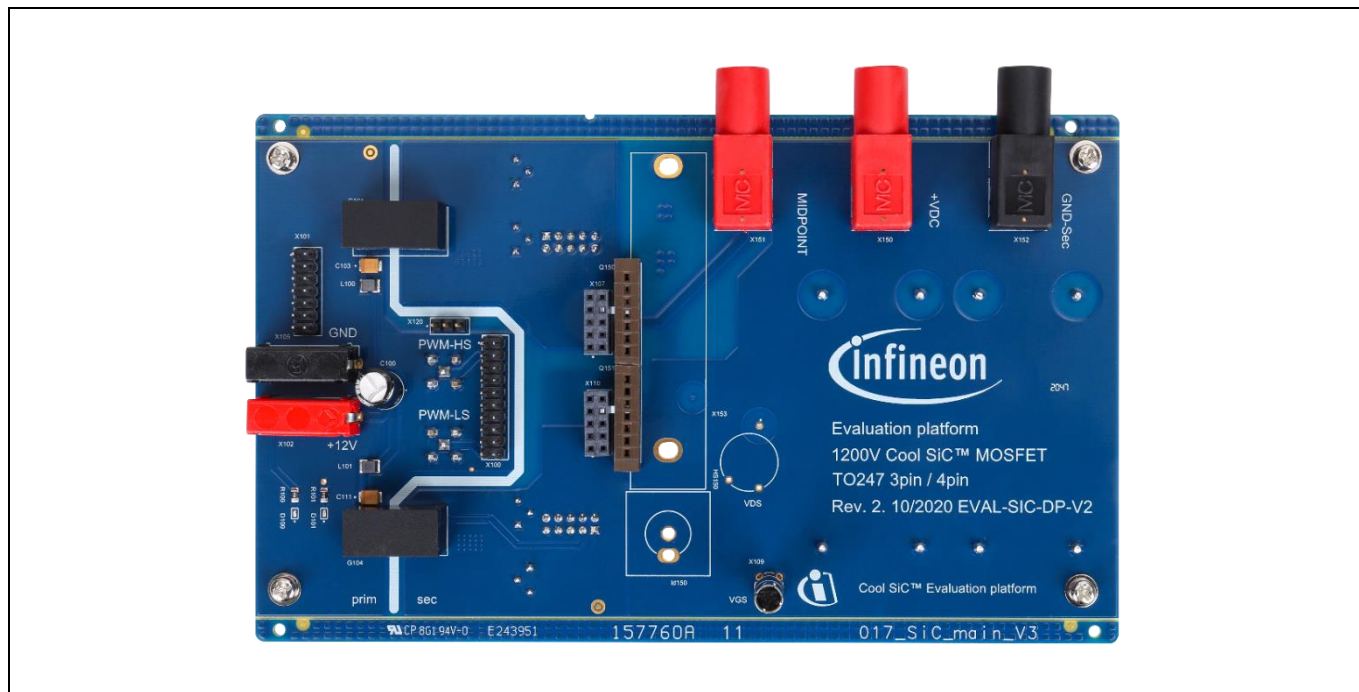


Figure 2 Evaluation platform top view

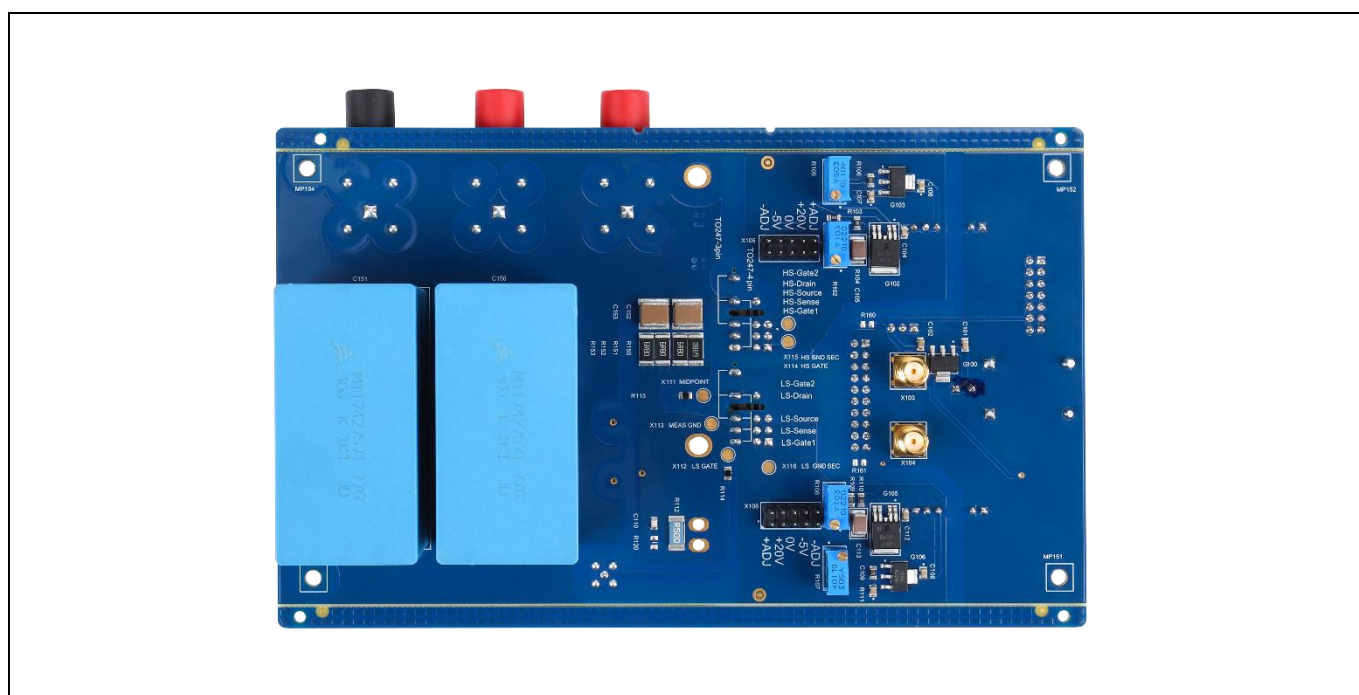


Figure 3 Evaluation platform bottom view

2.1 Commissioning

Connect your DC source to +VDC and GND-Sec. The inductor is plugged into the midpoint and to either the +VDC or GND-Sec, depending on the test to be used, as displayed in Figure 4. The left picture shows the routing for high-side DUT or low-side diode testing, and the right picture shows the opposite.

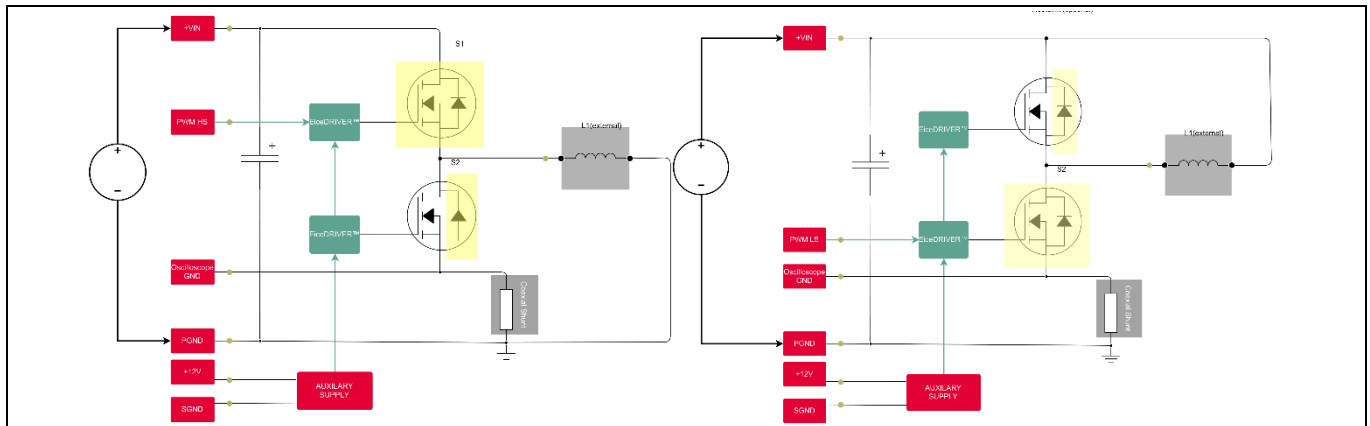


Figure 4 Test configurations

2.2 Description of the functional blocks

Figure 2 shows on the left side the +12V connectors for the auxiliary supply consuming on average 100 mA. Its functionality is indicated with the two LEDs D100 for +12 V and D101 for +5 V, which must be connected by setting a jumper on X120 to the drive card bridging 2 and 3 in Figure 5. The other possibility would be to bridge 1 and 2 for supplying the driver via the μ Controller.

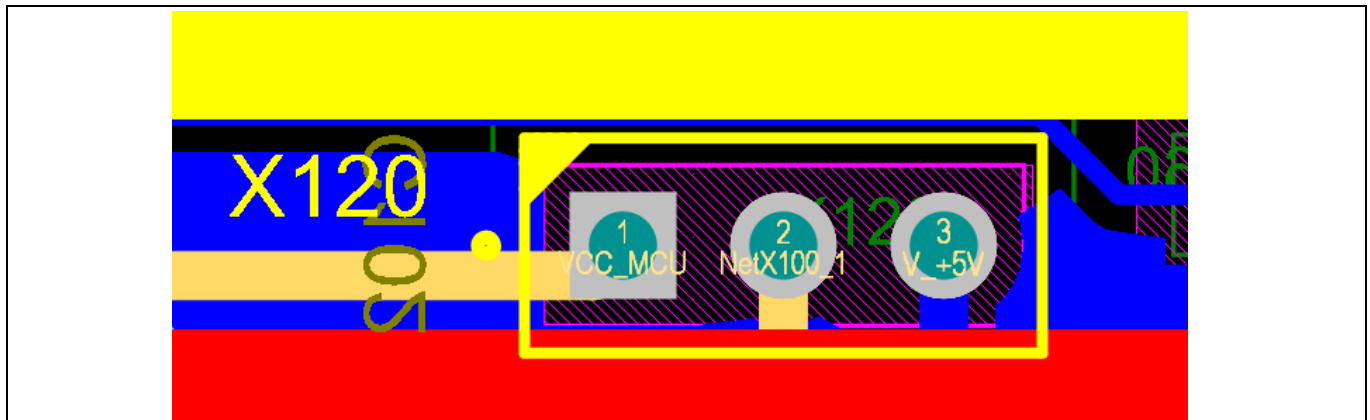


Figure 5 X120 jumper settings

X106 and X108 in Figure 6 are for setting the correct drive voltage on the daughter cards, ranging from +20 V to -5 V; Table 2 visualizes the possible combinations. +ADJ and -ADJ are set via the blue potentiometers R102, 105, 107 and 108.

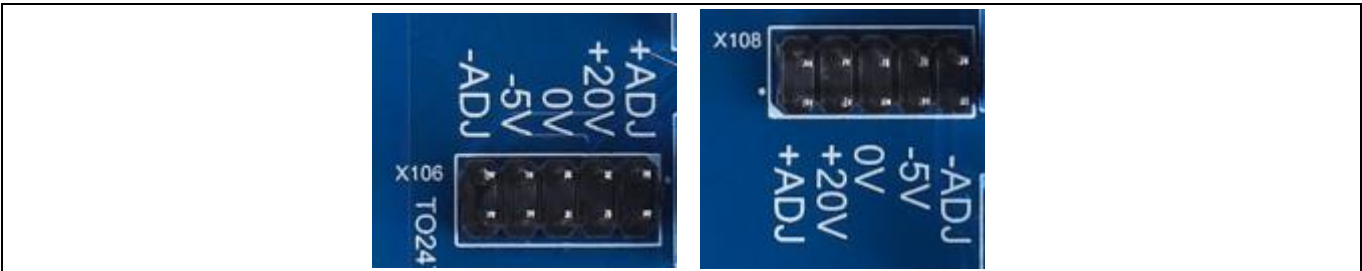


Figure 6 Drive voltage jumpers

Table 2 Possible jumper combinations

+ADJ	+20 V	0 V	-5 V	-ADJ
X		X		
X			X	
X				X
	X	X		
	X		X	
	X			X

The PWM comes either from the coaxial connectors X103, 104 or from the microcontroller via X101.

2.3 3-pin measurements

For 3-pin devices, the source and sense pins must be shorted via a solder bridge on the power connector, as indicated in Figure 7.

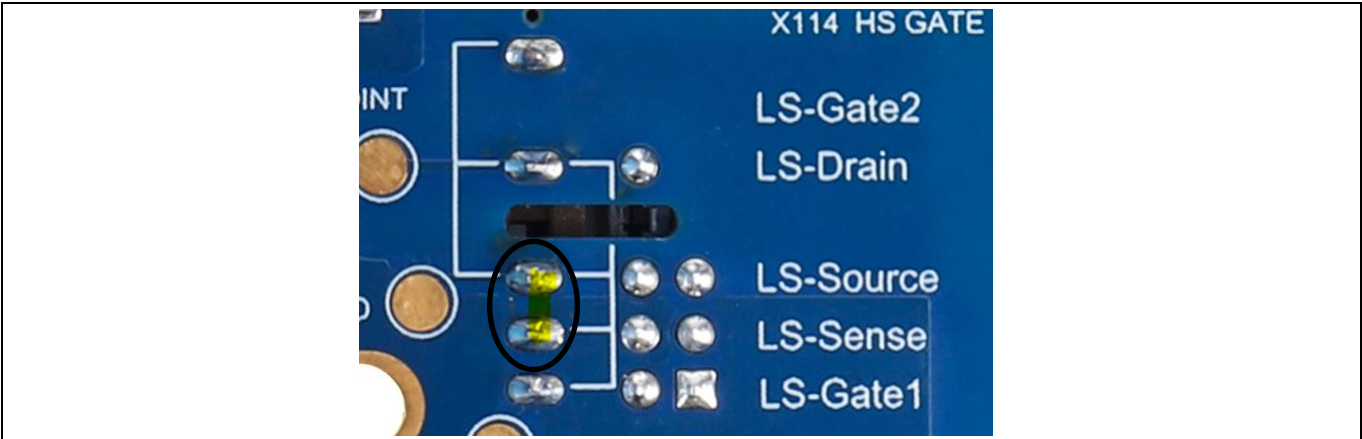


Figure 7 Bottom view power connector

3 System design

The complete design package is available on the download section of the Infineon homepage. A log-in is required to download this material.

3.1 Schematics

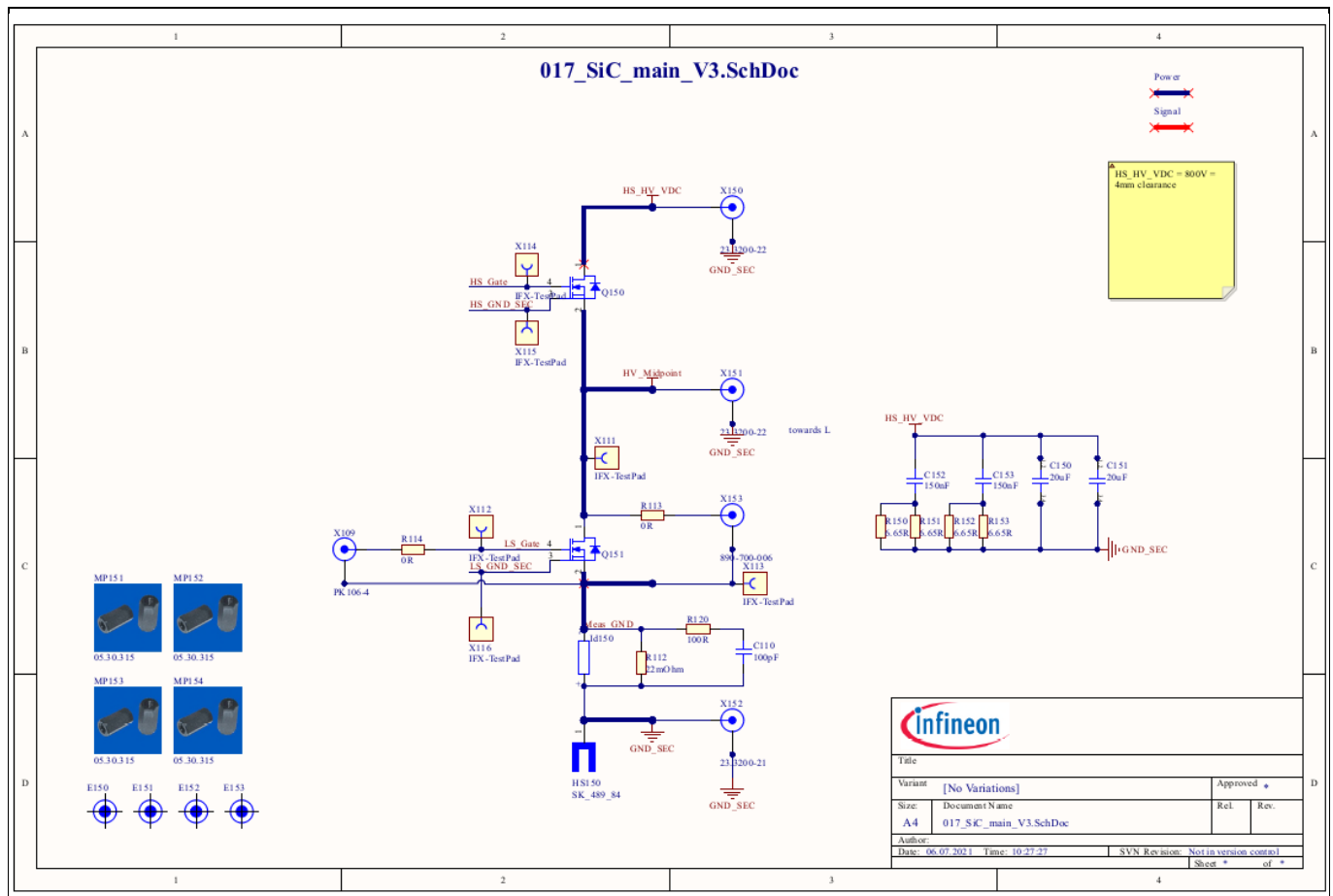


Figure 8 **Power circuit schematic diagram**

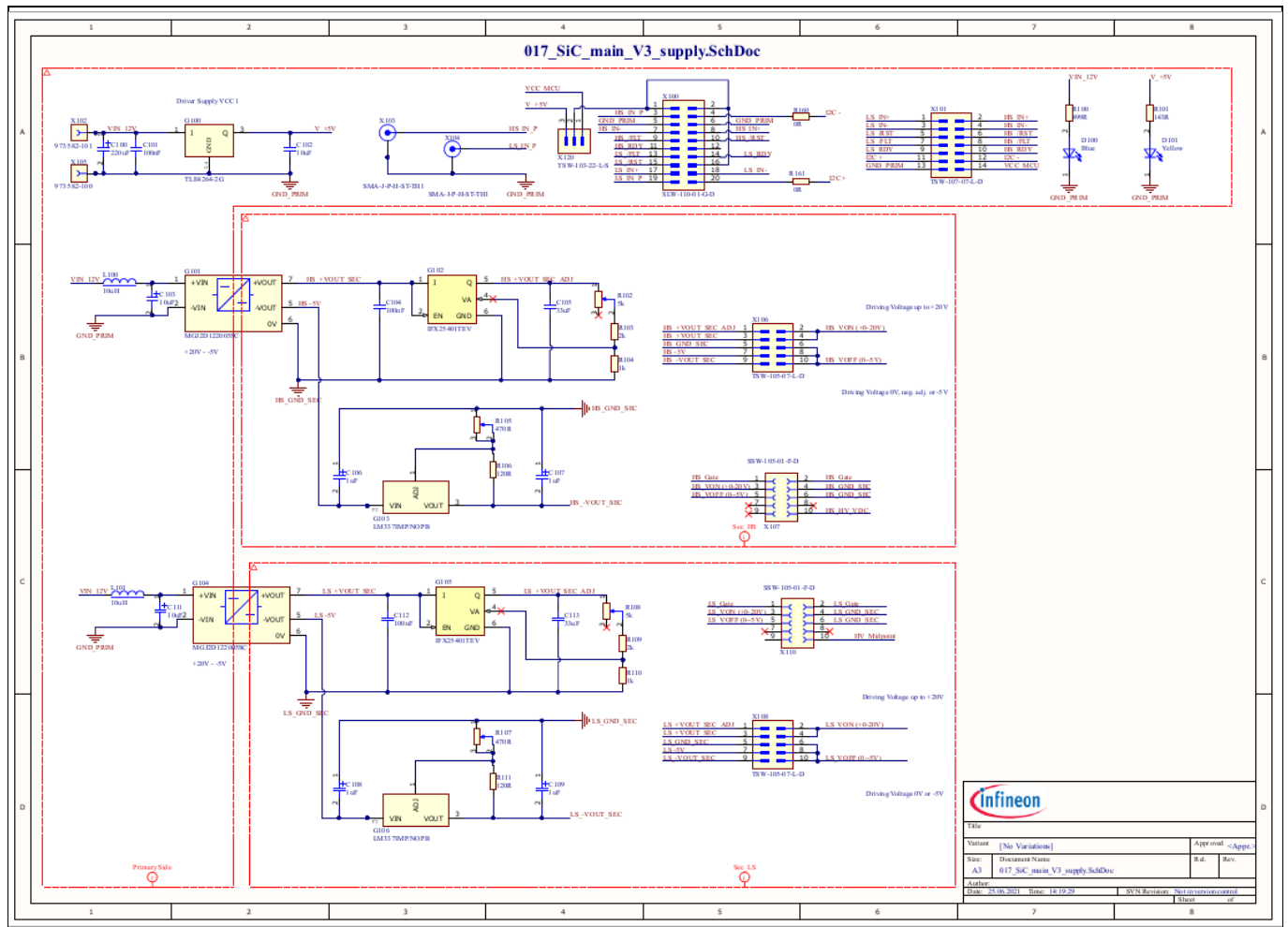


Figure 9 Main board auxiliary supply

4 System performance

The double-pulse principle is described in [1] in detail. One question that often arises is "What is the correct value for the inductor?" This is also described in [3]. Before powering the board, calculate if the shunt value is sufficient for the current through the DUT.

4.1 Test points

Choose the correct voltage-probe rating for the test point, and keep the ground loops as small as possible.

X111: Midpoint: half-bridge midpoint – high voltage

X112: LS GATE: low-side gate

X113: MEAS GND: measurement ground

X114: HS GATE: high-side gate, requires high-voltage differential probe

X115: HS GND SEC: high-side ground secondary, requires high-voltage differential probe

X116: LS GND SEC: low-side ground secondary

4.2 Start-up procedure

1. Mount drive card on motherboard, and set jumpers to the required supply voltage
2. Plug the DUTs into the connectors Q150, 151
3. Connect power source (VDC up to 800 V), auxiliary supply 12 V, function generator (for double pulse); setting current limits for safety reasons is recommended
4. Connect the load inductor, either HS or LS
5. Plug in the desired probes (voltage, current)
6. Turn-on procedure: A) Apply 12 V and double pulse; B) Apply high voltage gradually until desired level; C) Do measurements
7. Turn-off procedure: A) Switch off the high-voltage source; B) switch off Aux supply and function generator

5 References and appendices

5.1 Abbreviations and definitions

Table 3 Abbreviations

Abbreviation	Meaning
DUT	Device under test
PWM	Pulse width modulation
UL	Underwriters' Laboratories

5.2 References

- [1] Infineon Technologies AG. AN2019-28 (2019): 1200 V CoolSiC™ MOSFET in TO-247 3-/4-pin evaluation platform. V1.0 www.infineon.com
- [2] Infineon Technologies AG. UG-2021-17 (2021): EVAL-1ED020I12F2-DB user guide. Isolated driver daughter board to evaluate 1200 V CoolSiC™. V1.0 www.infineon.com
- [3] D. Levett, Z. Zheng, T. Frank, Double Pulse Testing: The How, What and Why, Bodo's Power Systems 2020, p. 30-35

5.3 Additional information

The isolated gate driver daughter card EVAL-1ED020I12F2-DB is designed to be used with this motherboard and can be ordered separately.

Revision history

Document version	Date of release	Description of changes
Rev 1.0	2021-08-20	First release
Rev 5.1	2021-11-2021	Daughter board cancelled

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